

Spec No.: DL-PCB0603SRW30 Rev No.: V.5 Date: Dec./13/2016 Page: 1 OF 11 HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED www.ledlight-components.com

Features:

- 1. Package in 8mm tape on 7" diameter reel.
- 2. Compatible with automatic placement equipment.
- 3. Compatible with infrared and vapor phase reflow solder process.
- 4. Bi-color type.
- 5. Color: Hyper Red. & Warm White
- **6.** The product itself will remain within RoHS compliant Version.

Descriptions:

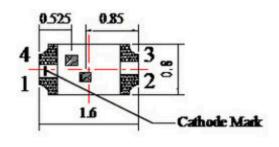
- 1. The SMD 0603 LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- 2. Besides, lightweight makes them ideal for miniature applications, etc.

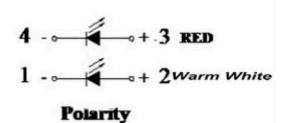
Applications:

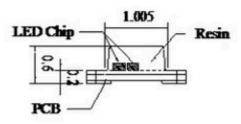
- 1. Automotive: Backlighting in dashboard and switch.
- 2. Telecommunication: Indicator and backlighting in telephone and fax.
- 3. Flat backlight for LCD, switch and symbol.
- 4. Status indicator.
- 5. General use.

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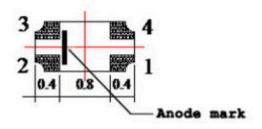
Package Dimension:

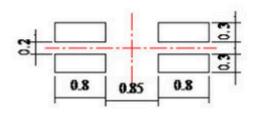






Recommended Soldering Pad Dimensions





Unit mm
Tolerance: ±0.10mm

| Part No. | Chip Material | | Lens Color | Source Color |
|-----------------|---------------|---------|-------------------|--------------|
| DL-PCB0603SRW30 | R | AlGaInP | Vallani Diffinand | Hyper Red |
| | W | InGaN | Yellow Diffused | Warm White |

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.10mm (.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.

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◆ Absolute Maximum Ratings at Ta=25°C

| Parameters | Symbol | Emitting Color | Max. | Unit | |
|--------------------------------------|--------|--------------------|------|------|--|
| Dower Dissipation | PD | Hyper Red | 65 | mW | |
| Power Dissipation | | Warm White | 85 | | |
| Peak Forward Current | IED | Hyper Red | 100 | | |
| (1/10 Duty Cycle, 0.1ms Pulse Width) | IFP | Warm White | 100 | mA | |
| Continuous Forward Current | IF | Hyper Red | 25 | | |
| Continuous Forward Current | | Warm White | 30 | mA | |
| Reverse Voltage | VR | 5 | | V | |
| Electrostatic Discharge (HBM) | ESD | 2000 | | V | |
| Operating Temperature Range | Topr | -40°C to +80°C | | ! | |
| Storage Temperature Range | Tstg | -40°C to +85°C | | | |
| Soldering Temperature | Tsld | 260℃ for 5 Seconds | | | |

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◆ Electrical Optical Characteristics at Ta=25°C

| Parameters | Symb ol | Emitting Color | Min. | Тур. | Max. | Unit | Test Condition |
|--------------------------|-------------------|----------------|------|------|------|-------|---------------------|
| Luminous Intensity | IV | Hyper Red | 80 | 150 | | mcd | IF=20mA (Note 1) |
| Luminous intensity | IV | Warm White | 250 | 400 | | ilicu | |
| Viewing Angle | 2θ _{1/2} | Hyper Red | | 120 | | Deg | IF=20mA |
| Viewing Angle | 201/2 | Warm White | | 120 | | Deg | (Note 2) |
| Peak Emission Wavelength | λр | Hyper Red | | 620 | | nm | |
| Chromaticity Coordinates | х | Warm White | 0.46 | | 0.50 | | IF=20mA |
| | Υ | warm winte | 0.42 | | 0.46 | | |
| Forward Voltage | VF | Hyper Red | 2.80 | 2.90 | 3.00 | V | IF=20mA |
| Forward Voltage | VF | Warm White | 1.80 | 2.00 | 2.10 | V | |
| Reverse Current | | Hyper Red | | | 10 | μА | V _R =5V |
| neverse current | IR | Warm White | | | | | |

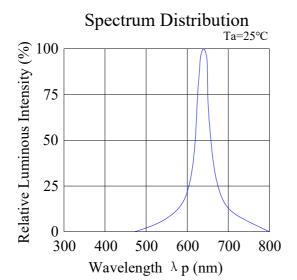
Notes:

- 1. Luminous Intensity Measurement allowance is ± 10%.
- 2. $\theta 1/2$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength (λd) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

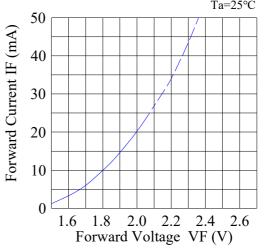
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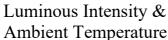
Typical Electrical / Optical Characteristics Curves

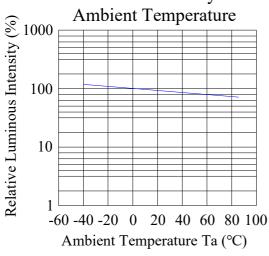
(25°C Ambient Temperature Unless Otherwise Noted) Hyper Red:



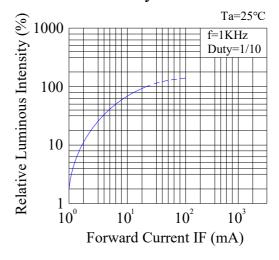
Forward Current & Forward Voltage Ta=25°C



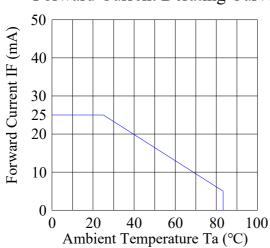




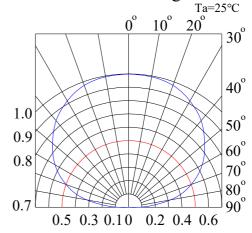
Luminous Intensity & Forward Current



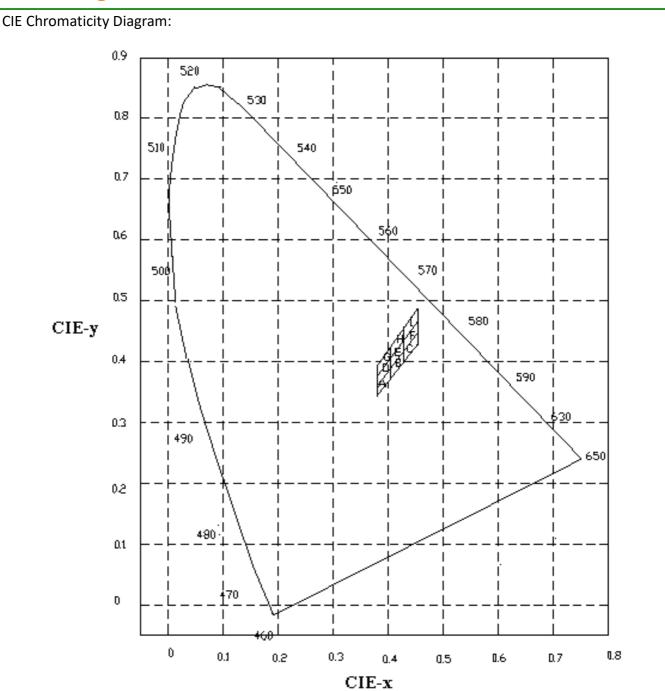
Forward Current Derating Curve



Radiation Diagram



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Chromaticity Coordinates Specifications for Bin Rank

(IF=20mA, Ta=25°C)

| Color | Group | Chromaticity Coordinate Group | | | | |
|------------|----------|-------------------------------|--------|--------|--------|--------|
| Warm White | Full | Х | 0.4600 | 0.4750 | 0.4850 | 0.5000 |
| | ruii | Υ | 0.4200 | 0.4350 | 0.4450 | 0.4600 |

Notes:

- 1. Color coordinates measurement allowance is \pm 0.01.
- 2. One delivery will include up to two consecutive color ranks and three luminous intensity ranks of the products the quantity-ratio of the ranks is decided by **Double Light**

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◆ Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

1) Test Items and Results:

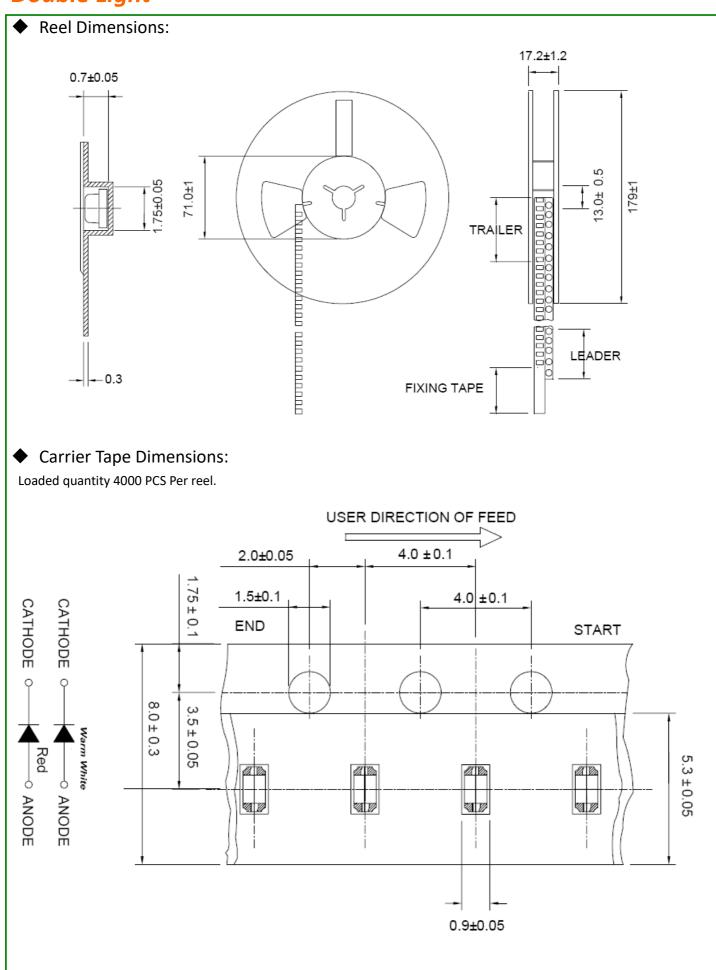
| No. | Test Item | Test Hours/Cycles | Test Conditions | Sample Size | Ac/Re |
|-----|------------------------------------|----------------------|--|-------------|-------|
| 1 | Resistance to Soldering Heat | 6 Min | Tsld=260±5℃, Min. 5sec | 25pcs | 0/1 |
| 2 | Thermal Shock | 300 Cycles | H: +100 $^{\circ}$ C 5min $∫$ 10 sec L: -10 $^{\circ}$ C 5min | 25pcs | 0/1 |
| 3 | Temperature Cycle | 300 Cycles | H: +100˚C 15min ∫ 5min L: -40˚C 15min | 25pcs | 0/1 |
| 4 | High Temperature Storage | 1000Hrs. | Temp: 100°C | 25pcs | 0/1 |
| 5 | DC Operating Life | 1000Hrs. | IF=20mA | 25pcs | 0/1 |
| 6 | Low Temperature Storage | 1000Hrs. | Temp: -40℃ | 25pcs | 0/1 |
| 7 | High Temperature/ High Humidity | 1000Hrs. | 85℃/85%RH | 25pcs | 0/1 |

2) Criteria for Judging the Damage:

| ltem | Symbol | Test Conditions | Criteria for Judgment | | |
|--------------------|--------|-----------------|-----------------------|------------|--|
| | | rest conditions | Min | Max | |
| Forward Voltage | VF | IF=20mA | | F.V.*)×1.1 | |
| Reverse Current | IR | VR=5V | | F.V.*)×2.0 | |
| Luminous Intensity | IV | IF=20mA | F.V.*)×0.7 | | |

*) F.V.: First Value.

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Please read the following notes before using the product:

1. Over-current-proof

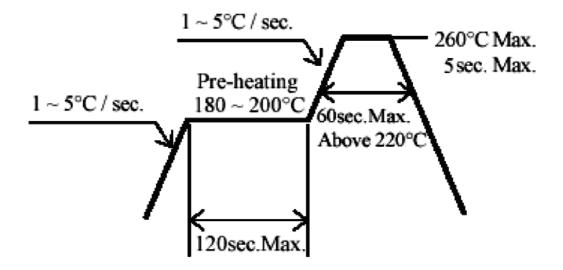
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture adsorbent material (silica gel) has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile.



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

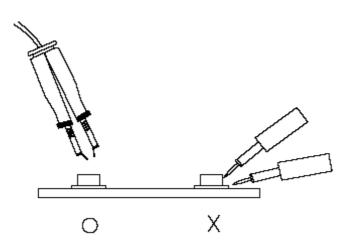
4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260°C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

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6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

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